

500V Super-junction Power MOSFET

Description

500V Super-junction Power MOSFET

Super-junction power MOSFET is a revolutionary technology for high voltage power MOSFETs, designed according to the SJ principle. The deep trench SJ MOSFET provide an extremely low switching, communication and conduction losses device with highest robustness make especially resonant switching applications more reliable, more efficient, lighter and cooler, designed by Wuxi Unigroup Microelectronics Company.

 Features Very low FOM R_{DS(on)}×Q_g 100% avalanche tested Easy to use/drive RoHS compliant 		Uninterruptible P	 Switch Mode Power Supply (SMPS) Uninterruptible Power Supply (UPS) Power Factor Correction (PFC) 		
TO-252	TO-251	Gate Gate Sour	RoHS		
Device Marking and	Package Information				
Device	Package		Marking		
TPD50R1K5CT	TO-252		50R1K5CT		
TPU50R1K5CT	TO-251		50R1K5CT		
Key Performance Pa	arameters				
Parameter	Value		Unit		
V _{DS} @ T _{j,max}	550		V		
R _{DS(on),max}	1.5		Ω		
Q _{g,typ}	5.3		nC		
I _D	2		A		
I _{D,pulse}	6		А		



Absolute Maximum Ratings $T_c = 25^{\circ}C$, unless otherwise noted						
Parameter		Symbol	Values	Unit		
Continuous Drain Current	T _C = 25°C	I _D	2	Α		
Pulsed Drain Current (no) I _{D,pulse}	6	А		
Gate-Source Voltage		V _{GSS}	±30V	V		
Single Pulse Avalanche Energy		E) E _{AS}	12	mJ		
Repetitive Avalanche Energy) E _{AR}	0.05	mJ		
Avalanche Current		I _{AR}	0.5	А		
Power Dissipation For TO-252,TO-251		P _D	17.8	W		
Continuous Diode Forward Current		I _S	2			
Diode Pulsed Current	(note	1) I _{S,pulse}	6	A		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55~+150	°C		

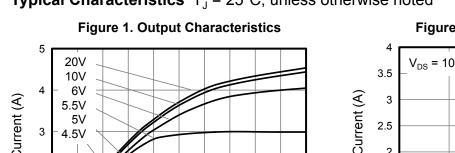
Thermal Resistance For TO-252,TO-251			
Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case	R _{thJC}	7.0	°C/W
Thermal Resistance, Junction-to-Ambient	R _{thJA}	62	-0/00

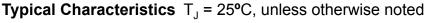


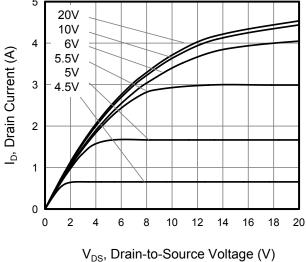
Specifications T _J = 25°C, ur	less othe	rwise noted				
	Symbol	Test Conditions	Value			
Parameter			Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0V, I_{D} = 250 \mu A$	500			V
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = 500V, V_{GS} = 0V, T_{J} = 25°C			1	μA
		V _{DS} = 500V, V _{GS} = 0V, T _J = 150°C			100	
Gate-Source Leakage	I _{GSS}	V_{GS} = $\pm 30V$			±100	nA
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1.1		2.5	V
Drain-Source On-Resistance (Note3)	$R_{\text{DS(on)}}$	V _{GS} = 10V, I _D = 1A		1.3	1.5	Ω
Forward Transconductance (Note3)	g _{fs}	V _{DS} = 10V, I _D = 1A		2		S
Dynamic						
Input Capacitance	C _{iss})/ _ 0)/		174		pF
Output Capacitance	C _{oss}	V _{GS} = 0V, V _{DS} = 50V,		10		
Reverse Transfer Capacitance	C _{rss}	f = 1.0MHz		1.5		
Total Gate Charge	Q _g			5.3		nC
Gate-Source Charge	Q _{gs}	$V_{DD} = 480V, I_D = 2A, V_{GS} = 10V$		1		
Gate-Drain Charge	Q_{gd}			2.7		
Turn-on Delay Time	t _{d(on)}			30		ns
Turn-on Rise Time	t _r	V_{DD} = 400V, I_D = 2A, R_G = 25 Ω		29		
Turn-off Delay Time	t _{d(off)}			54		
Turn-off Fall Time	t _f			31		
Drain-Source Body Diode Characteri	stics					
Continuous Body Diode Current	I _S	T 05%0			2	A
Pulsed Diode Forward Current	I _{SM}	T _C = 25°C			6	
Body Diode Voltage	V_{SD}	T_{J} = 25°C, I_{SD} = 2A, V_{GS} = 0V		0.9	1.2	V
Reverse Recovery Time	t _{rr}			150		ns
Reverse Recovery Charge	Q _{rr}	V _R = 480V, I _F = I _S , di _F /dt = 100A/µs		0.5		μC
Peak Reverse Recovery Current	I _{rrm}			6.0		А

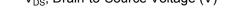
Notes

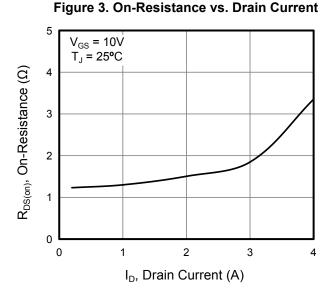
- 1. Repetitive Rating: Pulse Width limited by maximum junction temperature
- 2. I_{AS} = 1.5A, V_{DD} = 50V, R_{G} = 25 Ω , Starting T_{J} = 25°C
- 3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 1%



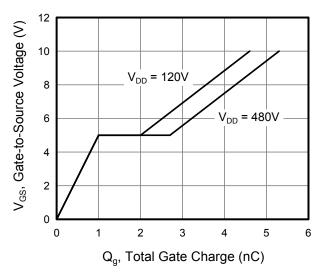


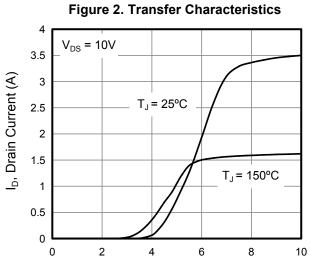












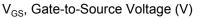


Figure 4. Capacitance

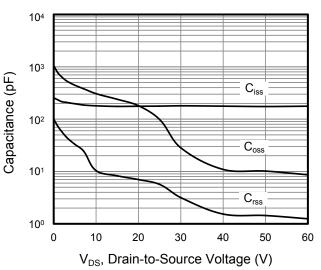
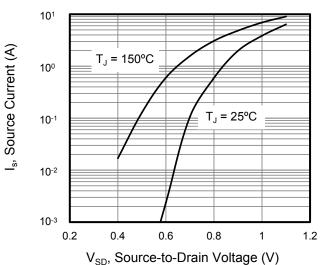
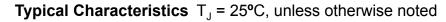


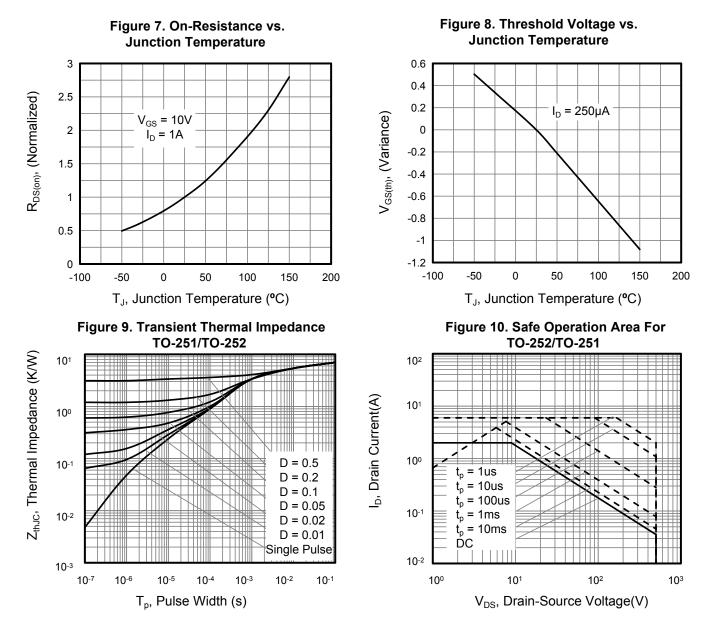
Figure 6. Body Diode Forward Voltage













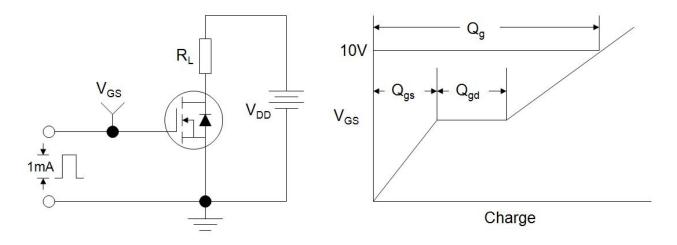


Figure B: Resistive Switching Test Circuit and Waveform

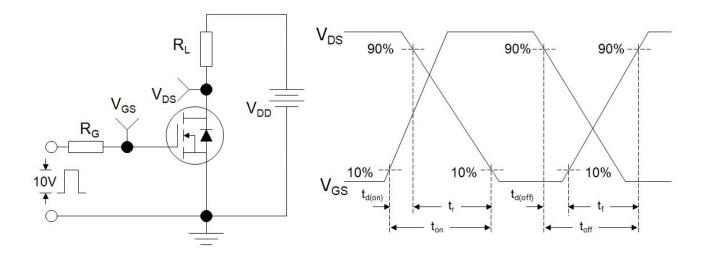
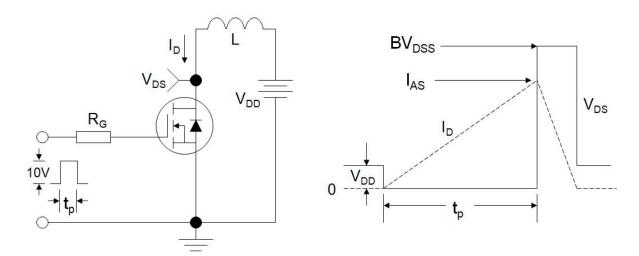


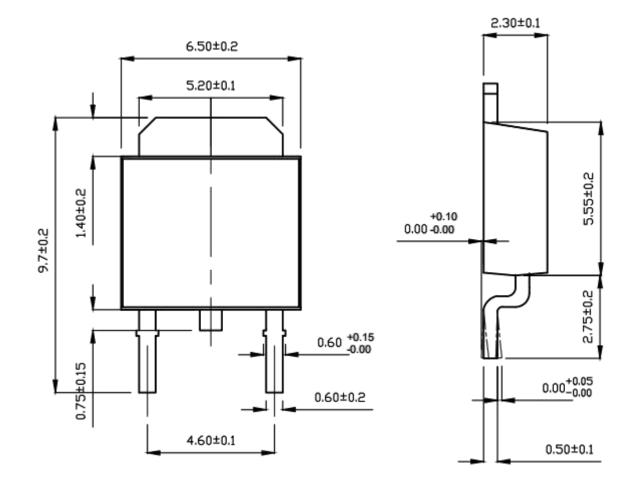
Figure C: Unclamped Inductive Switching Test Circuit and Waveform



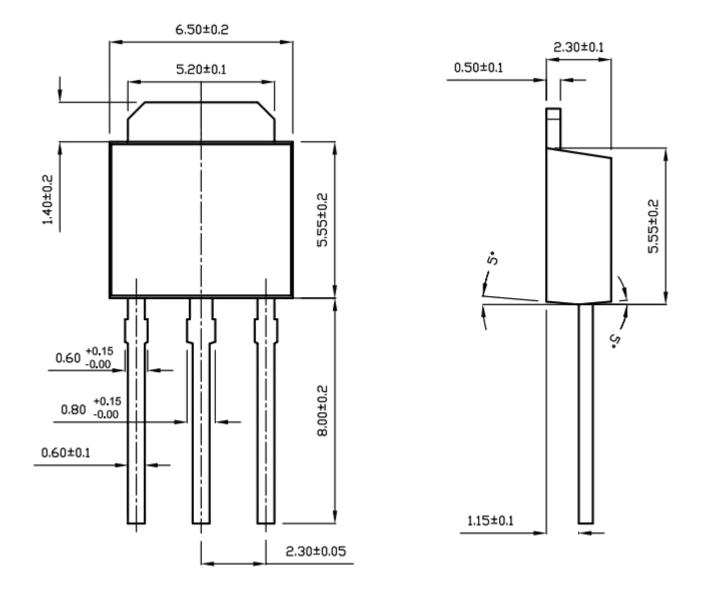
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Wuxi Unigroup Microelectronics Company

TO-252(封装厂 C)



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